

**TIAN-MA
MICROELECTRONICS CO., LTD**

DEVICE SPECIFICATION FOR LCD MODULE

Model No. TM8064CBC

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Approved by: 孙... ..	Date: 1/11-99

To: _____

CUSTOMER'S APPROVAL

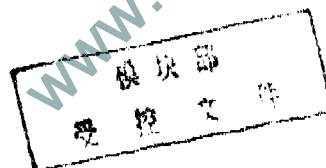
DATE _____

By: _____

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By: _____
Sell and Market Dep.

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REVISION RECORD

Date	Ref. Page	Revision No.	Revision Items	Check & Approval

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1 Display Specifications

1.1 Display type: STN

1.2 Display color*:

Display color: Blue-Black

Background color: yellow-green

1.3 Polarizer mode: Transflective/Positive

1.4 Viewing Angle: 6:00

1.5 Driving Duty: 1/65

1.6 Backlight: Led

* Color tone is slightly changed by temperature and driving voltage.

2 Mechanical Specifications

2.1 Outline Dimensions: Refer to outline drawing on page: 2

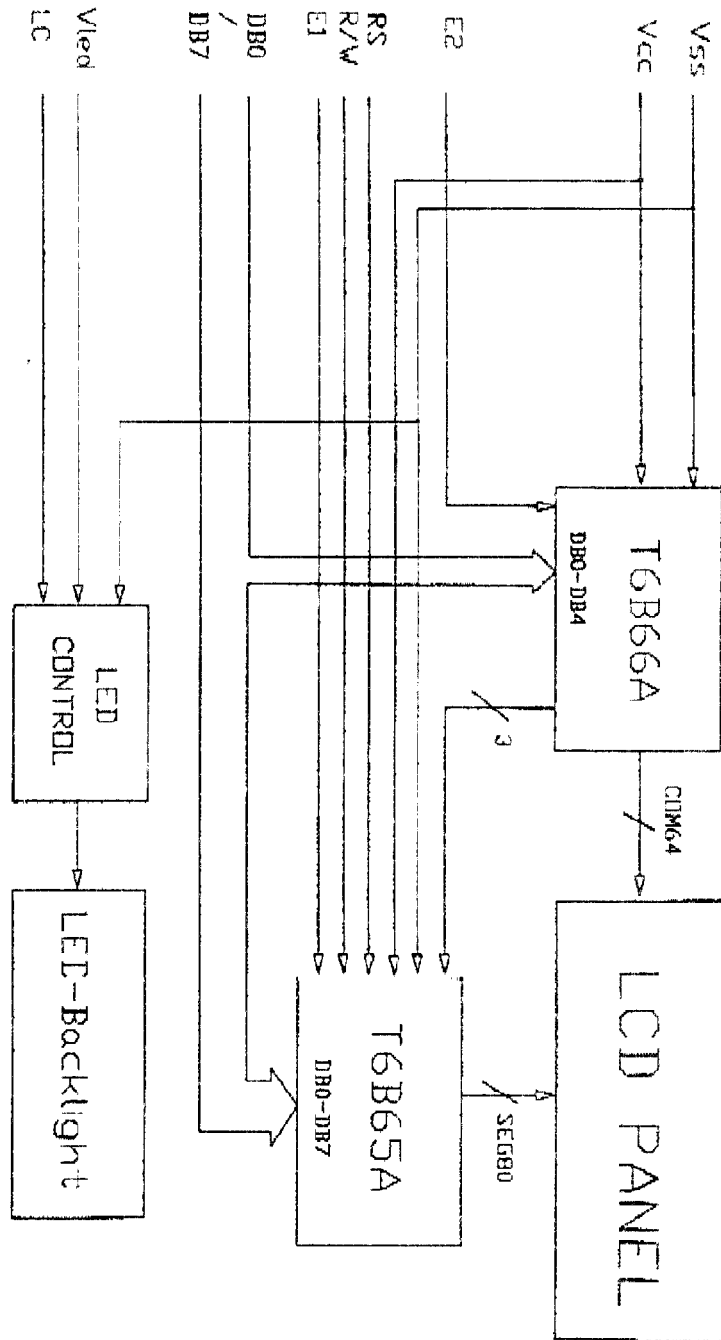
2.2 Dot Matrix: Refer to outline drawing on page: 2

2.3 Dot size: 0.481×0.481 (mm)

2.4 Dot pitch: 0.511×0.511 (mm)

2.5 Weight: 80g

3 Circuit Block Diagram



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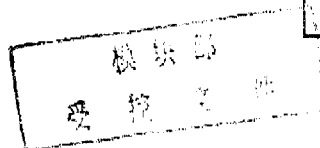
4 Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit	Remark
Power Supply Voltage	$V_{CC} - V_{SS}$	4.5	5.5	V	
LCD Driving Voltage	V_{LCD}	0	7V		
Operating Temperature Range	T_{OP}	0	50	°C	No Condensation
Storage Temperature Range	T_{ST}	-20	60		

5 Electrical Specifications and Instruction Code

5.1 Electrical characteristics

Item	Symbol	Min.	Typ.	Max.	Unit	Remark	
Supply Voltage (Logic)	$V_{CC} - V_{SS}$	4.5	5.0	5.5	V		
Supply Voltage (LCD Drive)	$V_{CC} - V_0$	-	11.5	-	V		
Input Signal Voltage	'H'Level	V_{IH}	2.2	-	V_{CC}	V	
	'L'Level	V_{IL}	-0.3	-	0.6	V	
Supply current (Logic)	I_{DD}	-	2.5		mA		
Supply current (LCD Drive)	I_{EE}	-	2.0		mA		



5.2 Interface Signals

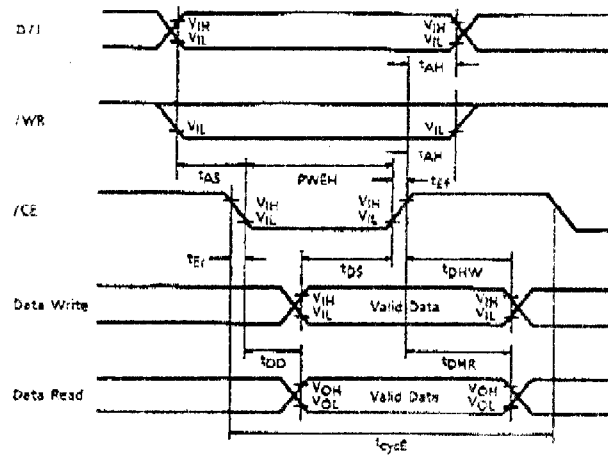
Pin No.	Symbol	Level	Description
1	Vss	0V	Ground
2	Vss	0V	Ground
3	Vcc	5.0V	Power supply voltage for logic and LCD(+)
4	Vled	5.0V	Power supply voltage for LED
5	Lc	H/L	BackLight control terminal
6	RS	H/L	Selection display data or instruction
7	E1	H/L	Chip enable singal
8	E2	H/L	Chip enable singal
9	R/W	H/L	Read/Write Singal
10	DB7	H/L	Data bit7
11	DB6	H/L	Data bit6
12	DB5	H/L	Data bit5
13	DB4	H/L	Data bit4
14	DB3	H/L	Data bit3
15	DB2	H/L	Data bit2
16	DB1	H/L	Data bit1
17	DB0	H/L	Data bit0

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5.3 Interface Timing Chart:

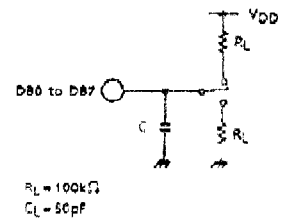
A. For T6B65



TEST CONDITIONS (1) ($V_{SS}=0V$, $V_{DD}=3.0V \pm 10\%$, $V_{LC5}=0V$, $T_a = -20$ to $75^\circ C$)

ITEM	SYMBOL	MIN	MAX	UNIT
Enable Cycle Time	t_{cycle}	1000	—	ns
Enable Pulse Width	P_{WEH}	450	—	ns
Enable Rise/Fall Time	t_{er} , t_{ef}	—	25	ns
Address Set-up Time	t_{AS}	40	—	ns
Address Hold Time	t_{AH}	10	—	ns
Data Set-up Time	t_{DS}	280	—	ns
Data Hold Time	t_{DHW}	10	—	ns
Data Delay Time	t_{DD} (Note)	—	300	ns
Data Hold Time	t_{DHR} (Note)	20	—	ns

LOAD CIRCUIT



TEST CONDITIONS (2) ($V_{SS}=0V$, $V_{DD}=5.0V \pm 10\%$, $V_{LC5}=0V$, $T_a = -20$ to $75^\circ C$)

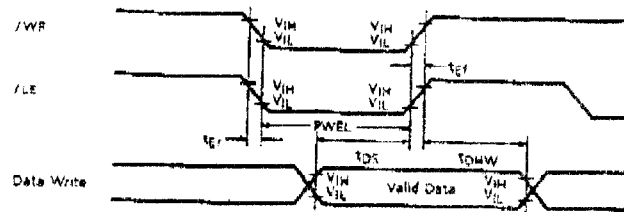
ITEM	SYMBOL	MIN	MAX	UNIT
Enable Cycle Time	t_{cycle}	500	—	ns
Enable Pulse Width	P_{WEH}	220	—	ns
Enable Rise/Fall Time	t_{er} , t_{ef}	—	20	ns
Address Set-up Time	t_{AS}	40	—	ns
Address Hold Time	t_{AH}	0	—	ns
Data Set-up Time	t_{DS}	60	—	ns
Data Hold Time	t_{DHW}	10	—	ns
Data Delay Time	t_{DD} (Note)	—	120	ns
Data Hold Time	t_{DHR} (Note)	20	—	ns

(Note) With load circuit connected

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B. For T6B66



TEST CONDITIONS (1) ($V_{SS} = 0V$, $V_{DD} = 3.0V \pm 10\%$, $V_{DD} - V_{EE} = 16V$, $T_a = -20$ to $75^\circ C$)

ITEM	SYMBOL	MIN	MAX	UNIT
Enable Rise / Fall Time	t_{Er} , t_{Ef}	—	25	ns
Enable Pulse Width	PWEL	60	—	ns
Data Set-up Time	t_{DS}	60	—	ns
Data Hold Time	t_{DHW}	10	—	ns

TEST CONDITIONS (2) ($V_{SS} = 0V$, $V_{DD} = 5.0V \pm 10\%$, $V_{DD} - V_{EE} = 16V$, $T_a = -20$ to $75^\circ C$)

ITEM	SYMBOL	MIN	MAX	UNIT
Enable Rise / Fall Time	t_{Er} , t_{Ef}	—	20	ns
Enable Pulse Width	PWEL	60	—	ns
Data Set-up Time	t_{DS}	60	—	ns
Data Hold Time	t_{DHW}	10	—	ns

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5.4 Instruction Code

A.T6B65

CODE											
/WR	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	FUNCTION	
0	0	0	0	0	0	0	0	1	1/0	Display ON (1) / OFF (0)	
0	0	0	0	0	0	0	1	Y/X	U/D	Y (1) / X (0) Counter Select UP (1) / Down (0) Mode Select	
0	0	0	0	0	0	1	*	*	*	Test Mode Select	
0	0	0	1	Z-Address (0 to 63)							Set Z-Address
0	0	1	0	X-Address (0 to 63)							Set X-Address
0	0	1	1	*	F/DR	Y (Page)-Address (0 to 9)				Set Y (Page)-Address	
1	0	B	0	D	R	0	F/DR	Y/X	U/D	Status Read (Note)	
0	1	Write Data								Write display data	
1	1	Read Data								Read display data	

* : INVALID

(Note) B : Busy flag
 D : Display ON (1) / OFF (0)
 R : Reset
 Y/X : Counter Select 1 : Y-Counter 0 : X-Counter
 U/D : Up/Down Select 1 : Up 0 : Down
 F/DR : Flag mode 1 : Flag mode 0 : Display RAM mode

B.T6B66

CODE						
DB5	DB4	DB3	DB2	DB1	DB0	FUNCTION
1	CONTRAST (0 to 31)					Set Contrast
0	1	1	*	*	*	Test Mode Select
0	1	0	1	1/0	1/0	Op-Amp Control OP1
0	1	0	0	*	1/0	Op-Amp ON/OFF
0	0	0	1	R ₁	R ₂	Bias Control
0	0	0	0	1	1/0	Display ON/OFF

* : INVALID

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6. Optical Characteristics

6.1 Optical Characteristics

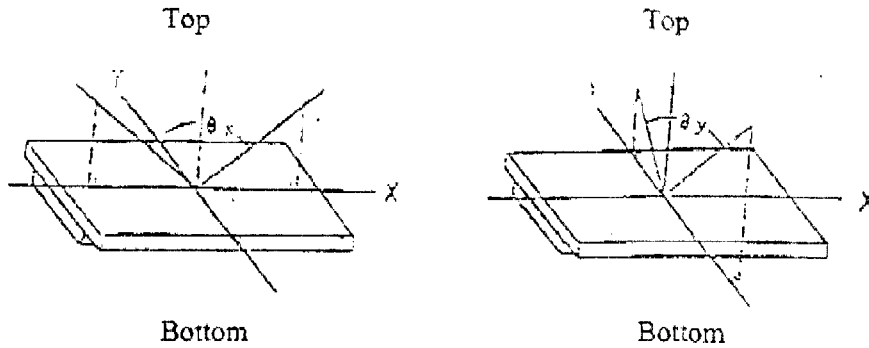
Top=25°C

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	Remark
Viewing Angle	θ_x	Cr>2 $\theta_y=0^\circ$	-35	--	10	Deg	
	θ_y						
Contrast Ratio	Cr	$\theta_x=0^\circ$ $\theta_y=0^\circ$	3.0				
Response Time	Turn on	$\theta_x=0^\circ$ $\theta_y=0^\circ$			150	ms	
	Turn off				Toff		

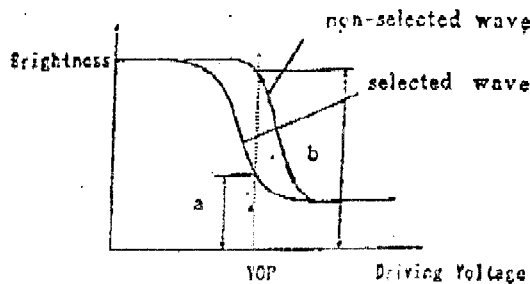
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6.2 Definition of optical characteristics

6.2.1 Definition of viewing Angle(see fig. as follow)



6.2.2 Definition of Contrast Ratio(see fig. as follow)

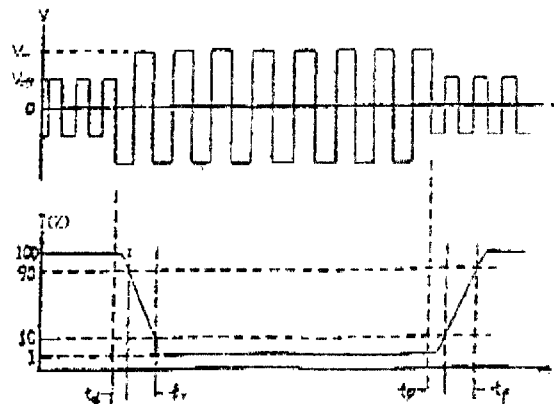


$$\text{Contrast Ratio} = b / a = \frac{\text{non-selected state brightness}}{\text{selected state brightness}}$$

Measuring Conditions:

- 1) Ambient Temperature: 25°C ; 2) Frame frequency: 64Hz

6.2.3 Definition of Response time(see fig. as follow)



$$\text{Turn-on time: } t_{on} = t_d + t_r$$

$$\text{Turn-off time: } t_{off} = t_d + t_r$$

Measuring Condition:

- 1) Operating Voltage: 11.5V ; 2) Frame frequency: 64Hz

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7.2 Failure Judgment Criterion

Criterion Item	Test Item No.									Failure Judgement Criterion
	1	2	3	4	5	6	7	8	9	
Basic Specification	0	0	0	0	0	0	0	0	0	Out of the basic Specification
Electrical specification	0	0	0	0	0					Out of the electrical specification
Mechanical Specification							0	0		Out of the mechanical specification
Optical Characteristic	0	0	0	0	0	0			0	Out of the optical specification
Remark	Basic specification = Optical specification + Mechanical specification									

8 Precautions for use of LCD Modules

8.1 Handling Precautions

- 8.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 8.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 8.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 8.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 8.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:

—Isopropyl alcohol

— Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

— Water

—Ketone

—Aromatic solvents

- 8.1.6 Do not attempt to disassemble the LCD Module.
- 8.1.7 If the logic circuit power is off, do not apply the input signals.
- 8.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - a. Be sure to ground the body when handling the LCD Modules.
 - b. Tools required for assembly, such as soldering irons, must be properly ground.
 - c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

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